

**International Journal of Current  
Microbiology and Applied Sciences  
(IJCMAS) NAAS RATING-5.38, ICV-95.39**  
ISSN: 2319-7692 (Print) ISSN 2319-7706 (Online)

An International, Monthly, Online, Free Access, Peer Reviewed,  
Indexed, fast track Scientific Research Journal

**Certificate of Publication**

This is to certify that the following article reviewed by editorial board and published in International Journal of Current Microbiology and Applied Sciences (IJCMAS) ISSN: 2319-7692 (Print) ISSN 2319-7706 (Online).

Int.J.Curr.Microbiol.App.Sci.2017.6.(2):270-284

<http://dx.doi.org/10.20546/ijcmas.2017.602.033>

Monitoring the Effect of Additive Agents and Other Parameters on Copper Deposition by Electro Refining Process

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*International Journal of Current Microbiology and Applied Sciences*

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